ESDM3051

5V ESD Protection Diode

Micro-Packaged Diodes for ESD Protection

The ESDM3051 is designed to protect voltage sensitive components that require low capacitance from ESD and transient voltage events. Excellent clamping capability, low capacitance, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

Features

- Low Clamping Voltage
- Small Body Outline Dimensions: 0.62 mm x 0.32 mm
- Low Body Height: 0.3 mm
- Stand-off Voltage: 5 V
- IEC61000-4-2 Level 4 ESD Protection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- USB ID Line Protection
- µSD Card Protection
- Audio Line Protection
- GPIO

MAXIMUM RATINGS

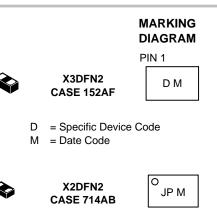
Rating	Symbol	Value	Unit
IEC 61000–4–2 (ESD) Contact Air		±30 ±30	kV
Total Power Dissipation on FR–5 Board (Note 1) @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction–to–Ambient	Ρ _D R _{θJA}	250 400	mW °C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. FR-5 = $1.0 \times 0.75 \times 0.62$ in. ON

ON Semiconductor®

www.onsemi.com





JP = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
ESDM3051MXT5G	X3DFN2 (Pb–Free)	10000 / Tape & Reel
ESDM3051N2T5G	X2DFN2 (Pb–Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

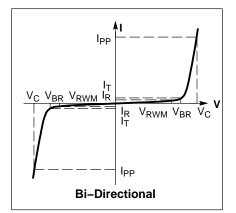
See Application Note AND8308/D for further description of survivability specs.

Semiconductor Components Industries, LLC, 2017 September, 2018 – Rev. 3

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Symbol	Parameter		
I _{PP}	Maximum Reverse Peak Pulse Current		
V _C	Clamping Voltage @ I _{PP}		
V _{RWM}	Working Peak Reverse Voltage		
I _R	Maximum Reverse Leakage Current @ V _{RWM}		
V _{BR}	Breakdown Voltage @ I _T		
Ι _Τ	Test Current		



*See Application Note AND8308/D for detailed explanations of datasheet parameters.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}				5.0	V
Breakdown Voltage (Note 2)	V _{BR}	I _T = 1 mA	5.1		7.0	V
Reverse Leakage Current	I _R	V _{RWM} = 5 V			0.1	μA
Clamping Voltage (Note 3)	V _C	I _{PP} = 1 A			6.0	V
Clamping Voltage (Note 3)	V _C	I _{PP} = 8 A			8.2	V
Peak Pulse Current (Note 3)	I _{PP}	t _P = 8/20 μs	9.9			А
Clamping Voltage TLP (Note 4)	V _C	$I_{PP} = 16 \text{ A}$ $\begin{cases} \text{IEC } 6100042 \text{ Level } 4 \text{ equivalent} \\ (\pm 8 \text{ kV Contact}, \pm 15 \text{ kV Air}) \end{cases}$		7.5		V
Junction Capacitance	CJ	V _R = 0 V, f = 1 MHz			21	pF
Dynamic Resistance	R _{DYN}	TLP Pulse		0.11		Ω
Insertion Loss		f = 10 MHz		0.01		dB

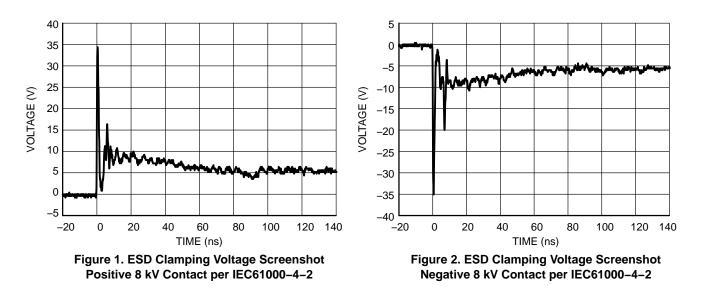
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Breakdown voltage is tested from pin 1 to 2 and pin 2 to 1.

3. Non-repetitive current pulse at $T_A = 25^{\circ}$ C, per IEC61000–4–5 waveform. 4. ANSI/ESD STM5.5.1 – Electrostatic Discharge Sensitivity Testing using Transmission Line Pulse (TLP) Model.

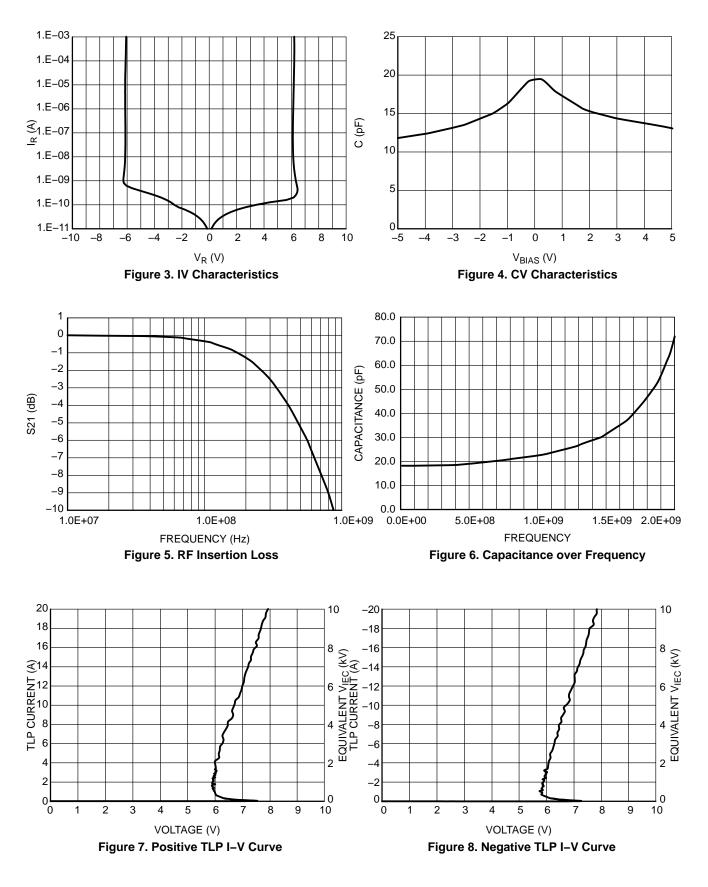
TLP conditions: $Z_0 = 50 \Omega$, $t_p = 100 \text{ ns}$, $t_r = 4 \text{ ns}$, averaging window; $t_1 = 30 \text{ ns}$ to $t_2 = 60 \text{ ns}$.

TYPICAL CHARACTERISTICS



ESDM3051

TYPICAL CHARACTERISTICS



ESDM3051

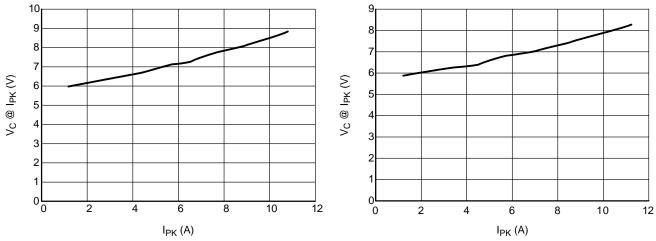


Figure 9. Positive Clamping Voltage vs. Peak Pulse Current (tp = 8/20 μ s)

Figure 10. Negative Clamping Voltage vs. Peak Pulse Current (tp = $8/20 \ \mu$ s)

IEC 61000-4-2 Spec.

Level	Test Volt- age (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8

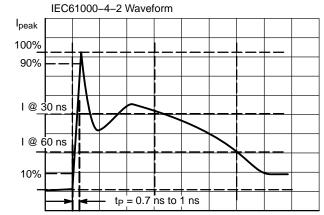


Figure 11. IEC61000-4-2 Spec

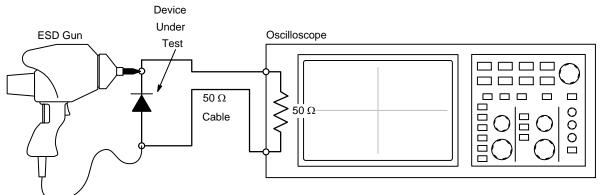
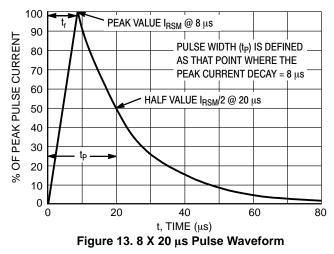


Figure 12. Diagram of ESD Test Setup

ESD Voltage Clamping

For sensitive circuit elements it is important to limit the voltage that an IC will be exposed to during an ESD event to as low a voltage as possible. The ESD clamping voltage is the voltage drop across the ESD protection diode during an ESD event per the IEC61000–4–2 waveform. Since the IEC61000–4–2 was written as a pass/fail spec for larger systems such as cell phones or laptop computers it is not clearly defined in the spec how to specify a clamping voltage

at the device level. ON Semiconductor has developed a way to examine the entire voltage waveform across the ESD protection diode over the time domain of an ESD pulse in the form of an oscilloscope screenshot, which can be found on the datasheets for all ESD protection diodes. For more information on how ON Semiconductor creates these screenshots and how to interpret them please refer to AND8307/D.



Transmission Line Pulse (TLP) Measurement

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 14. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 15 where an 8 kV IEC 61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP I–V curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels.

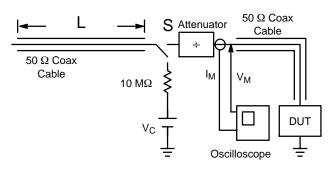


Figure 14. Simplified Schematic of a Typical TLP System

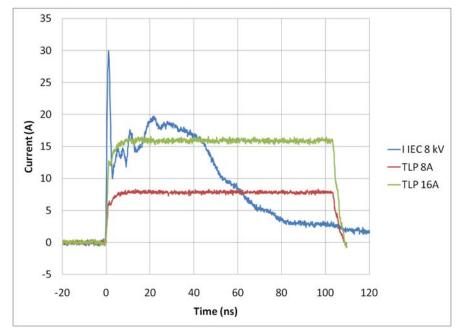
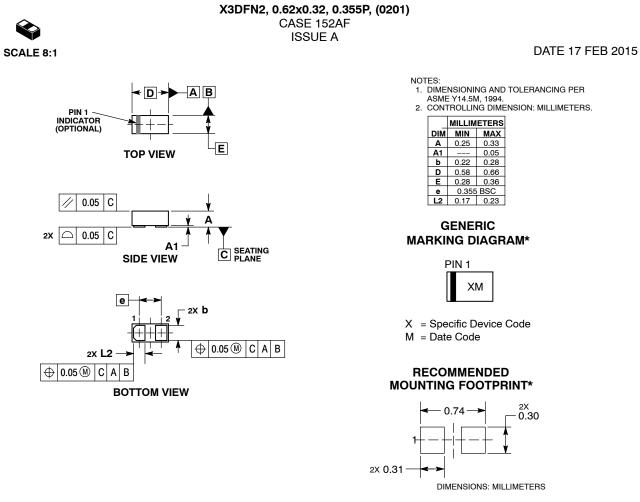


Figure 15. Comparison Between 8 kV IEC 61000-4-2 and 8 A and 16 A TLP Waveforms





See Application Note AND8398/D for more mounting details

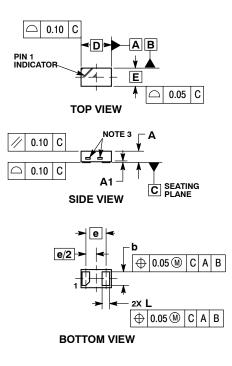
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

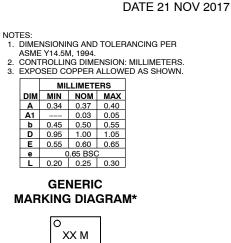
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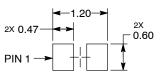
SCALE 8:1





XX = Specific Device Code M = Date Code

RECOMMENDED SOLDER FOOTPRINT*



DIMENSIONS: MILLIMETERS

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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